02/12/2019 505324695

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YU GU	01/30/2019
GUAN HUEI SEE	01/30/2019
PENG SUO	01/30/2019
PRAYUDI LIANTO	01/20/2019
ARVIND SUNDARRAJAN	02/01/2019

RECEIVING PARTY DATA

Name:	APPLIED MATERIALS SINGAPORE TECHNOLOGY PTE. LTD.	
Street Address:	et Address: 8 UPPER CHANGI ROAD NORTH	
Internal Address:	APPLIED MATERIALS BUILDING	
City:	SINGAPORE	
State/Country:	tate/Country: SINGAPORE	
Postal Code: 506906		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16251355

CORRESPONDENCE DATA

Fax Number: (732)935-7122

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 732-935-7100

Email: Izaveta@mtiplaw.com

MOSER TABOADA/ALAN TABOADA **Correspondent Name:**

1030 BROAD STREET Address Line 1:

Address Line 2: SUITE 203

Address Line 4: SHREWSBURY, NEW JERSEY 07702

ATTORNEY DOCKET NUMBER:	44016287US1
NAME OF SUBMITTER:	ALAN TABOADA
SIGNATURE:	/ALAN TABOADA/
DATE SIGNED:	02/12/2019

PATENT REEL: 048308 FRAME: 0099 505324695

Total Attachments: 2

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PATENT REEL: 048308 FRAME: 0100

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Name and Address of Inventor:

YU GU

Apt Blk 354B, Admiralty Drive #06-252 SINGAPORE, 752354

GUAN HUEI SEE

Blk 662 Yishun Ave. 4 #07-251 SINGAPORE, 760662

PENG SUO

10 SCIENCE PARK ROAD, #01-01B THE ALPHA SCIENCE PARK 2 SINGAPORE, 117684

PRAYUDI LIANTO

620 Bukit Batok Central #18-522 SINGAPORE, 760662

ARVIND SUNDARRAJAN

80 Holland Road, Apt 09-04 SINGAPORE, 258875

(hereinafter referred to as Assignor), has invented a certain invention entitled:

METHODS FOR FORMING VIAS IN POLYMER LAYERS

for which I have filed an application for a Patent of the United States on January 18, 2019, Serial No. 16/251,355; and

WHEREAS, Applied Materials Singapore Technology Pte. Ltd., a company organized under the laws of Singapore, having a place of business at 8 Upper Changi Road North, Applied Materials Building, Singapore 506906 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignor, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

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PATENT REEL: 048308 FRAME: 0101 NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignor hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- Said Assignor hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignor shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.
- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignor, his respective heirs, legal representatives and assigns.
- 4. Said Assignor hereby warrant and represent that he has not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignor have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	0//3~/2019 (Date)	TOZUM.
2)	07/30/2019 Date)	YÜ GÜ
** /		GUAN HUEFSEE
3)	0//30/2019(Date)	PENG Sud
4)	01/30/2019 (Date)	9
	· • • •	PRAYUDI LIANTO
5)	2/1/20(9 (Date)	NACASSAGUES CHIVSA
	2/1/20(9 (Date)	Allerin

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